

GooLED-VOS-6830 Pin Fin LED Heat Sink Φ68mm for Vossloh-Schwabe

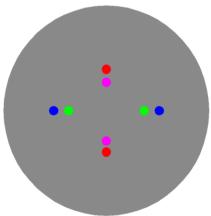
Features VS Benefits

- * The GooLED-VOS-6830 Vossloh-Schwabe Pin Fin LED Heat Sinks are specifically designed for luminaires using the Vossloh-Schwabe LED engines.
- * Mechanical compatibility with direct mounting of the LED engines to the LED cooler and thermal performance matching the lumen packages.
- * For spotlight and downlight designs from 800 to 2,100 lumen.
- * Thermal resistance range Rth 4.0°C/W.
- * Modular design with mounting holes foreseen for direct mounting of Vossloh-Schwabe COB series.
- * Diameter 68.0mm standard height 30.0mm Other heights on request.
- * Forged from highly conductive aluminum.

Zhaga LED engine and radiator assembly is a unified future international standardization

- * Below you find an overview of Vossloh-Schwabe COB's and LED modules which standard fit on the Pin Fin LED Heat Sinks.
- * In this way mechanical after work and related costs can be avoided, and lighting designers can standardize their designs on a limited number of LED Pin Fin LED Heat Sink.





Vossloh-Schwabe LED Modules directly Mounting Options Vossloh-Schwabe LUGA Shop Gen. 5/ Gen.6 COB Series (13.5*13.5): :

DMS124***H; DMS123***G:

With the Zhaga Book 11 holders for the green indicator marks.

AAG.STUCCHI: 8100-G2

Without the holders for the pink indicator marks. Direct mounting with machine screws M3x6.5mm

Vossloh-Schwabe LUGA Shop Gen. 5/ Gen.6 COB Series (19.0*19.0):

DMS125***H; DMS126***H; DMS126***G;

Vossloh-Schwabe LUGA Shop TW COB Series:

Without the holders for the red indicator marks.

Direct mounting with machine screws M3x6.5mm.



GOOLED

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Mounting Options and Drawings & Dimensions

Example:GooLED-VOS-6830-B-1,2

Example:GooLED-VOS-68 1 - 2 -

1 Height (mm)

Anodising Color

B-Black

C-Clear

Z-Custom

Mounting Options - see graphics for details Combinations available

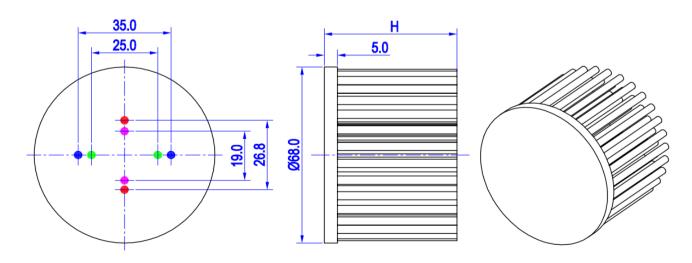
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means option 1 and 2 combined

Notes:

- Mentioned models are an extraction of full product range.
- For specific mechanical adaptations please contact MingfaTech.
- MingfaTech reserves the right to change products or specifications without prior notice.

| MOUNTING OPTION | Module type | Holder NO. | THREAD | THREAD DEPTH | THREAD HOLE DISTANCE |
|--------------------|---------------------------|------------------------------|--------|-----------------|------------------------------------|
| 1 | COB series (13.5*13.5) | / | М3 | 6.5mm | 19.0mm/ 2-@180° |
| 2 | | BJB Holder 47.319.6294.50 | М3 | 6.5mm | 25.0mm/ 2-@180° (Zhaga book 11) |
| | | AAG.STUCCHI 8100-G2 | МЗ | 6.5mm | |
| 3 | COB series (19.0*19.0) | / | | | 26.8mm/ 2-@180° |
| 4 | | BJB Holder 47.319.2021.50 | | | 35.0mm/ 2-@180° (Zhaga book 3) |
| | | AAG.STUCCHI 8101-G2 | | | |





The product deta table

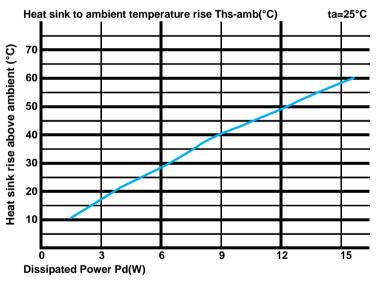


| Model No. | GooLED-VOS-6830 | | |
|--------------------------------|-----------------|--|--|
| Heatsink Size | Ф68хH30mm | | |
| Heatsink Material | AL1070 | | |
| Finish | Black Anodized | | |
| Weight (g) | 108.0 | | |
| Dissipated power (Ths-amb,50℃) | 12.5 (W) | | |
| Cooling surface area (mm²) | 36775 | | |
| Thermal Resistance (Rhs-amb) | 4.0 (°C/W) | | |

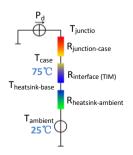
The thermal data table

- * Please be aware the dissipated power Pd is not the same as the electrical power Pe of a LED module.
- *To calculate the dissipated power please use the following formula: $Pd = Pe \times (I \eta L)$.
 - Pd Dissipated power ; Pe Electrical power ; $\eta L = \text{Light effciency of the LED module};$

| Pd = Pe x (1-ηL) | | Heat sink to ambient thermal resistance Rhs-amb (°C/W) | Heat sink to ambient temperature rise Ths-amb (°C) |
|------------------------|------|--|--|
| | | GooLED-VOS-6830 | |
| Dissipated Power Pd(W) | 3.0 | 5.67 | 17.0 |
| | 6.0 | 4.67 | 28.0 |
| | 9.0 | 4.44 | 40.0 |
| | 12.0 | 4.08 | 49.0 |
| | 15.0 | 3.87 | 58.0 |



- *The aluminum substrate side of the package outer shell is thermally connected to the heat sink via TIM (Thermal interface material).
- $\label{thm:mingFa} \mbox{MingFa recommends the use of a high thermal conductive interface between the LED module and the LED cooler.}$
- $Either thermal\ grease, A\ thermal\ pad\ or\ a\ phase\ change\ thermal\ pad\ thickness\ 0.\ I-0.\ I\ 5mm\ is\ recommended.$



- *Thermal resistance is a heat property and a measurement of a temperature difference by which an object or material resists a heat flow. Geometric shapes are different, the thermal resistance is different. Formula: $\theta = (Ths Ta)/Pd$
- $\theta\,$ Thermal Resistance [°C/W] ; Ths - Heatsink temperature ; Ta - Ambient temperature ;
- *The thermal resistance between the junction section of the light-emitting diode and the aluminum substrate side of the package outer shell is $R_{junction-case}$, the thermal resistance of the TIM outside the package is $R_{interface (TIM)}[^{\circ}C/M]$, the thermal resistance with the heat sink is $R_{heatsink-ambient}[^{\circ}C/M]$, and the ambient temperature is $T_{ambient}[^{\circ}C]$.
- *Thermal resistances outside the package $R_{interface (TIM)}$ and $R_{heatsink-ambient}$ can be integrated into the thermal resistance $R_{case-ambient}$ at this point. Thus, the following formula is also used: $T_{junction} = (R_{junction-case} + R_{case-ambient}) \cdot Pd + T_{ambient}$

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